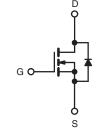
Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY							
V _{DS} (V)	200						
R _{DS(on)} (Ω)	V _{GS} = 10 V 0.40						
Q _g (Max.) (nC)	43						
Q _{gs} (nC)	7.0						
Q _{gd} (nC)	23						
Configuration	Sing	le					





N-Channel MOSFET

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- Surface Mount
- Available in Tape and Reel
- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The D²PAK is a surface mount power package capable of accommodating die sizes up to HEX-4. It provides the highest power capability and the lowest possible on-resistance in any existing surface mount package. The D²PAK is suitable for high current applications because of its low internal connection resistance and can dissipate up to 2.0 W in a typical surface mount application.

ORDERING INFORMATION			
Package	D ² PAK (TO-263)	D ² PAK (TO-263)	D ² PAK (TO-263)
Lead (Pb)-free and Halogen-free	SiHF630S-GE3	SiHF630STRL-GE3ª	SiHF630STRR-GE3ª
Lead (Pb)-free	IRF630SPbF	IRF630STRLPbF ^a	IRF630STRRPbF ^a
Leau (FD)-iree	SiHF630S-E3	SiHF630STL-E3 ^a	SiHF630STR-E3 ^a

Note

a. See device orientation.

ABSOLUTE MAXIMUM RATINGS (Г _C = 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage	V _{DS}	200	N/		
Gate-Source Voltage	V _{GS}	± 20	V		
Continuous Drain Current	V _{GS} at 10 V	T _C = 25 °C	1-	9.0	
Continuous Drain Current	VGS at 10 V	T _C = 100 °C	I _D	5.7	А
Pulsed Drain Current ^a			I _{DM}	36	
Linear Derating Factor				0.59	W/°C
Linear Derating Factor (PCB Mount) ^e				0.025	- W/ C
Single Pulse Avalanche Energy ^b			E _{AS}	250	mJ
Repetitive Avalanche Current ^a			I _{AR}	9.0	А
Repetitive Avalanche Energy ^a			E _{AR}	7.4	mJ
Maximum Power Dissipation	T _C =	25 °C	P	74	14/
Maximum Power Dissipation (PCB Mount) ^e	T _A =	25 °C	P _D	3.0	
Pb containing terminations are not RoHS complia	ant, exemptions m	ay apply			•
Peak Diode Recovery dV/dt ^c	dV/dt	5.0	V/ns		

Document Number: 91032 S11-1047-Rev. C, 30-May-11 www.vishay.com

RoHS'

COMPLIANT HALOGEN FREE

Vishay Siliconix



ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)								
PARAMETER	SYMBOL	LIMIT	UNIT					
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to + 150	°C					
Soldering Recommendations (Peak Temperature)	for 10 s		300 ^d	U U				

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. $V_{DD} = 50 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 4.6 mH, $R_g = 25 \Omega$, $I_{AS} = 9.0 \text{ A}$ (see fig. 12). c. $I_{SD} \le 9.0 \text{ A}$, dI/dt $\le 120 \text{ A/}\mu\text{s}$, $V_{DD} \le V_{DS}$, $T_J \le 150 \text{ °C}$.

d. 1.6 mm from case.

e. When mounted on 1" square PCB (FR-4 or G-10 material).

THERMAL RESISTANCE RATINGS							
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	-	-	40	20.414		
Maximum Junction-to-Ambient	R _{thJA}	-	-	62	°C/W		
Maximum Junction-to-Case (Drain)	R _{thJC}	-	-	1.7			

SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$,	unless otherwi	se noted)					
PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNI
Static		•				•	•
Drain-Source Breakdown Voltage	V _{DS}	V _{GS}	_s = 0, I _D = 250 μA	200	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.24	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μΑ	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 20 V$		-	-	± 100	nA
Zero Gate Voltage Drain Current		V _{DS} =	= 200 V, V _{GS} = 0 V	-	-	25	
Zero Gate voltage Drain Current	I _{DSS}	V _{DS} = 160V	V_{DS} = 160V, V_{GS} = 0 V, T_{J} = 125 °C		-	250	μA
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	$I_D = 5.4 \text{ A}^{b}$	-	-	0.40	Ω
Forward Transconductance	9 _{fs}	V _{DS} =	= 50 V, I _D = 5.4 A ^b	3.8	-	-	S
Dynamic					-	-	
Input Capacitance	C _{iss}		$V_{GS} = 0 V,$	-	800	-	
Output Capacitance	C _{oss}		$V_{DS} = 25 V,$	-	240	-	pF
Reverse Transfer Capacitance	C _{rss}	f = 1	.0 MHz, see fig. 5	-	76	-	
Total Gate Charge	Qg			-	-	43	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	I _D = 5.9 A, V _{DS} = 160 V see fig. 6 and 13 ^b	-	-	7.0	nC
Gate-Drain Charge	Q _{gd}			-	-	23	
Turn-On Delay Time	t _{d(on)}			-	9.4	-	
Rise Time	t _r		= 100 V, I _D = 5.9 A	-	28	-	
Turn-Off Delay Time	t _{d(off)}	- Kg =	= 12 Ω, R _D = 16 Ω see fig. 10 ^b	-	39	-	ns
Fall Time	t _f		-	-	20	-	
Internal Drain Inductance	L _D	Between lead 6 mm (0.25") f	from	-	4.5	-	n⊔
Internal Source Inductance	L _S	package and die contact	center of	-	7.5	-	- nH

Document Number: 91032 S11-1047-Rev. C, 30-May-11



Vishay Siliconix

SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT		
Drain-Source Body Diode Characteristics								
Continuous Source-Drain Diode Current	Is	MOSFET symbol showing the	-	-	9.0			
Pulsed Diode Forward Current ^a	I _{SM}	p - n junction diode	-	-	36	A		
Body Diode Voltage	V _{SD}	$T_J = 25 \ ^{\circ}C, \ I_S = 9.0 \ A, \ V_{GS} = 0 \ V^b$	-	-	2.0	V		
Body Diode Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = 5.9 A,	-	170	340	ns		
Body Diode Reverse Recovery Charge	Q _{rr}	dl/dt = 100 A/µs ^b	-	1.1	2.2	μC		
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by L_{S} and $L_{D})$						

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

c. When mounted on 1" square PCB (FR-4 or G-10 material).

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

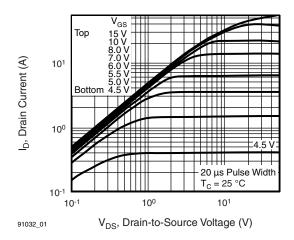


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

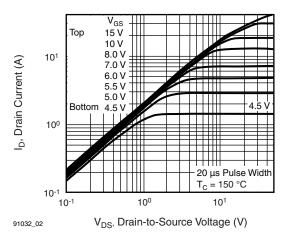


Fig. 2 - Typical Output Characteristics, $T_C = 150 \ ^\circ C$

Vishay Siliconix



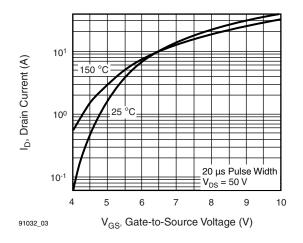
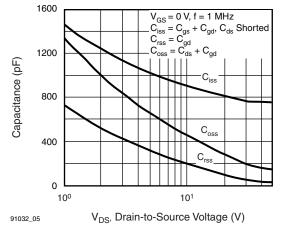
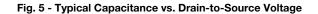


Fig. 3 - Typical Transfer Characteristics





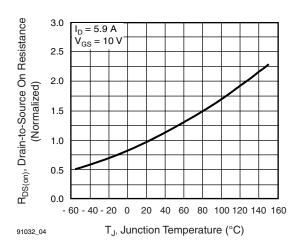


Fig. 4 - Normalized On-Resistance vs. Temperature

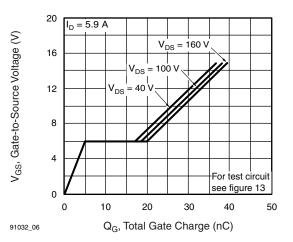


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

Document Number: 91032 S11-1047-Rev. C, 30-May-11



Vishay Siliconix

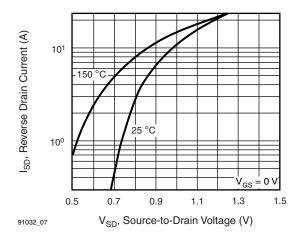


Fig. 7 - Typical Source-Drain Diode Forward Voltage

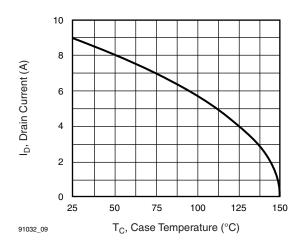


Fig. 9 - Maximum Drain Current vs. Case Temperature

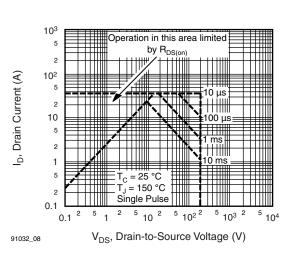


Fig. 8 - Maximum Safe Operating Area

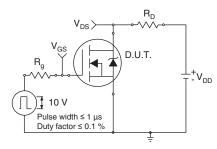


Fig. 10a - Switching Time Test Circuit

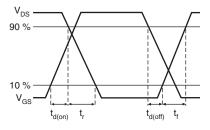


Fig. 10b - Switching Time Waveforms

Document Number: 91032 S11-1047-Rev. C, 30-May-11

Vishay Siliconix



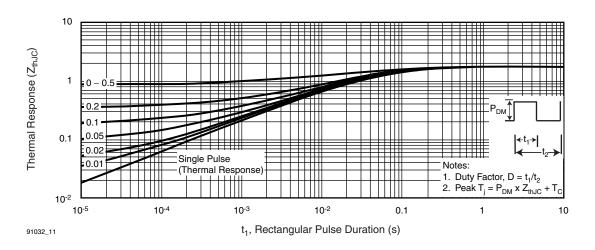


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

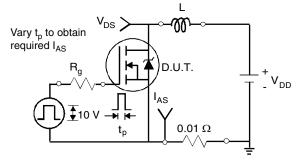


Fig. 12a - Unclamped Inductive Test Circuit

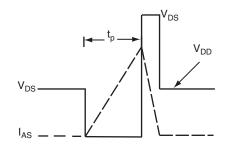
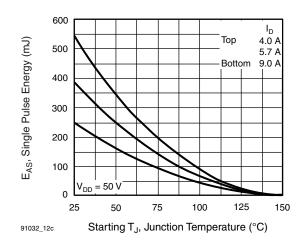


Fig. 12b - Unclamped Inductive Waveforms

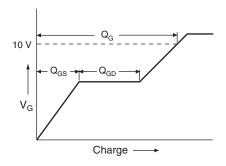




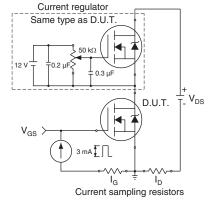
www.vishay.com 6 Document Number: 91032 S11-1047-Rev. C, 30-May-11



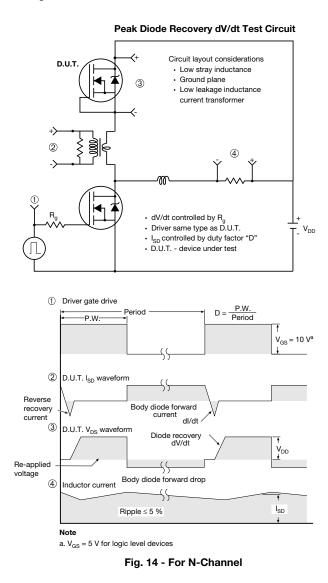
Vishay Siliconix











Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91032.

Document Number: 91032 S11-1047-Rev. C, 30-May-11 www.vishay.com

H

A1

B

Gauge plane

L3

Detail "A" Rotated 90° CW scale 8:1

0° to 8° **Vishay Siliconix**

Seating plane

TO-263AB (HIGH VOLTAGE)

∕3 ⁄4 A

н

∕₅∖

Detail A

(Datum A)

D

 $\underline{4}$ 11

	2	-	▼ 2 x b2 2 x b ⊕ 0.010 @ A(DB ating b1, b b1, b (c) (c)	$\begin{array}{c} c_{1} \\ c_{1} \\ c_{2} \\ c_{3} \\ c_{4} \\ c_{5} \\ c_{7} \\$	a - 1		l l	1 4	
	MILLIN	IETERS	INC	HES			MILLIN	IETERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.		DIM.	MIN.	MAX.	MIN.	MAX.
А	4.06	4.83	0.160	0.190		D1	6.86	-	0.270	-
A 4	0.00	0.25	0.000	0.010		Е	9.65	10.67	0.380	0.420
A1	0.00	0.25								
b A1	0.51	0.25	0.020	0.039		E1	6.22	-	0.245	-
			0.020 0.020	0.039 0.035		E1 e		- BSC	0.245 0.100	BSC
b	0.51	0.99						- BSC 15.88		- BSC 0.625
b b1	0.51 0.51	0.99 0.89	0.020	0.035		е	2.54		0.100	
b b1 b2	0.51 0.51 1.14	0.99 0.89 1.78	0.020 0.045	0.035		e H	2.54 14.61	15.88	0.100 0.575	0.625
b b1 b2 b3	0.51 0.51 1.14 1.14	0.99 0.89 1.78 1.73	0.020 0.045 0.045	0.035 0.070 0.068		e H L	2.54 14.61 1.78	15.88 2.79	0.100 0.575 0.070	0.625 0.110
b b1 b2 b3 c	0.51 0.51 1.14 1.14 0.38	0.99 0.89 1.78 1.73 0.74	0.020 0.045 0.045 0.015	0.035 0.070 0.068 0.029		e H L L1	2.54 14.61 1.78 - -	15.88 2.79 1.65	0.100 0.575 0.070 -	0.625 0.110 0.066 0.070
b b1 b2 b3 c c1	0.51 0.51 1.14 1.14 0.38 0.38	0.99 0.89 1.78 1.73 0.74 0.58	0.020 0.045 0.045 0.015 0.015	0.035 0.070 0.068 0.029 0.023		e H L L1 L2	2.54 14.61 1.78 - -	15.88 2.79 1.65 1.78	0.100 0.575 0.070 - -	0.625 0.110 0.066 0.070

Α

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Dimensions are shown in millimeters (inches).

3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.

4. Thermal PAD contour optional within dimension E, L1, D1 and E1.

5. Dimension b1 and c1 apply to base metal only.

6. Datum A and B to be determined at datum plane H.

7. Outline conforms to JEDEC outline to TO-263AB.



www.vishay.com

1



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Vishay:

IRF630SPBF IRF630STRLPBF IRF630STRRPBF IRF630S IRF630STRL